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APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.
10/006,462	12/04/2001	Steven R. Walther	V0077/7165WRM	5689
7.	590 06/22/2005		EXAM	INER
Gary L. Loser, Esq.			CROWELL, ANNA M	
	Varian Semiconductor Equipment Associates, Inc.			D. DED MID IDED
35 Dory Road			ART UNIT	PAPER NUMBER
Gloucester, MA 01930			1763	
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Please find below and/or attached an Office communication concerning this application or proceeding.

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	Application No.	Applicant(s)				
	10/006,462	WALTHER, STEV	EN R.			
Office Action Summary	Examiner	Art Unit				
	Michelle Crowell	1763				
The MAILING DATE of this communication app Period for Reply	ears on the cover sheet w	vith the correspondence ad	dress			
A SHORTENED STATUTORY PERIOD FOR REPLY THE MAILING DATE OF THIS COMMUNICATION.  - Extensions of time may be available under the provisions of 37 CFR 1.13 after SIX (6) MONTHS from the mailing date of this communication.  - If the period for reply specified above is less than thirty (30) days, a reply of NO period for reply is specified above, the maximum statutory period was reply received by the Office later than three months after the mailing earned patent term adjustment. See 37 CFR 1.704(b).	36(a). In no event, however, may a y within the statutory minimum of thi vill apply and will expire SIX (6) MO , cause the application to become A	reply be timely filed  irty (30) days will be considered timely  NTHS from the mailing date of this co  BANDONED (35 U.S.C. § 133).				
Status						
1) Responsive to communication(s) filed on 31 M	larch 2005.					
2a) This action is <b>FINAL</b> . 2b) ☑ This	action is non-final.		•			
	Since this application is in condition for allowance except for formal matters, prosecution as to the merits is closed in accordance with the practice under <i>Ex parte Quayle</i> , 1935 C.D. 11, 453 O.G. 213.					
Disposition of Claims			. •			
<ul> <li>4)  Claim(s) 1-33 is/are pending in the application.</li> <li>4a) Of the above claim(s) 6-9,15-17 and 28-33</li> <li>5)  Claim(s) is/are allowed.</li> <li>6)  Claim(s) 1-5, 10-14, and 18-27 is/are rejected.</li> <li>7)  Claim(s) is/are objected to.</li> <li>8)  Claim(s) are subject to restriction and/or</li> </ul>	is/are withdrawn from co	nsideration.				
Application Papers			•			
9) The specification is objected to by the Examine 10) The drawing(s) filed on is/are: a) acce Applicant may not request that any objection to the o Replacement drawing sheet(s) including the correct 11) The oath or declaration is objected to by the Ex	epted or b) objected to drawing(s) be held in abeya ion is required if the drawing	nce. See 37 CFR 1.85(a). g(s) is objected to. See 37 CF	• •			
Priority under 35 U.S.C. § 119	•		. •			
12) Acknowledgment is made of a claim for foreign a) All b) Some * c) None of:  1. Certified copies of the priority documents 2. Certified copies of the priority documents 3. Copies of the certified copies of the prior application from the International Bureau * See the attached detailed Office action for a list	s have been received. s have been received in A nity documents have beer u (PCT Rule 17.2(a)).	Application No n received in this National	Stage			
Attachment(s)  1) Notice of References Cited (PTO-892)  2) Notice of Draftsperson's Patent Drawing Review (PTO-948)  3) Information Disclosure Statement(s) (PTO-1449 or PTO/SB/08)  Paper No(s)/Mail Date	Paper No	Summary (PTO-413) (s)/Mail Date Informal Patent Application (PTC 	D-152)			
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### **DETAILED ACTION**

#### Continued Examination Under 37 CFR 1.114

A request for continued examination under 37 CFR 1.114, including the fee set forth in 37 CFR 1.17(e), was filed in this application after final rejection. Since this application is eligible for continued examination under 37 CFR 1.114, and the fee set forth in 37 CFR 1.17(e) has been timely paid, the finality of the previous Office action has been withdrawn pursuant to 37 CFR 1.114. Applicant's submission filed on March 31, 2005 has been entered.

# Claim Rejections - 35 USC § 103

- 1. The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:
  - (a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negatived by the manner in which the invention was made.
- 2. Claims 1-4 are rejected under 35 U.S.C. 103(a) as being unpatentable over Liebert et al. (U.S. 6,020,592) in view of Foster et al. (U.S. 5,567,243) or Vesnovsky et al. (U.S. 6,209,481).

Referring to Figure 1 and column 4, line 32-column 5, line 33, Liebert et al. discloses a

plasma doping apparatus comprising: a plasma doping chamber 10; a platen 14 located in the plasma doping chamber for supporting a workpiece 20 (col. 4, lines 32-36); an anode 24 spaced apart from the platen in the plasma doping chamber (col.4, lines 44-46); a process gas source 36 coupled to the plasma doping chamber, wherein a plasma

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containing ion of the process gas is produced in a plasma discharge region between the anode and the platen (col.5, lines 4-8); a pulse source 30 for applying pulses between the platen and the anode for accelerating ions from the plasma into the workpiece (col.4, lines 50-57, col.5, lines 22-33).

Liebert et al. fails to teach a mechanism for rotating the workpiece with rotational speed in a range of about 10-600 rpm for averaging azimuthal uniformity variations over the surface of the workpiece.

Referring to Figure 2 and column 12, line 36-column 14, line 48, Foster et al. discloses a plasma processing apparatus comprising a mechanism for rotating the platen 46 such that the workpiece 48 rotates about its center at a rotational speed between 0-2000 rpm to ensure uniform processing and desired processing rate (col. 13, lines 49-65, col. 8, lines 23-25). Additionally, plasma is pumped down to the substrate by using a rotating platen (col.4, lines 30-31). Moreover, referring to column 1, lines 62-65 and column 8, lines 37-40, Vesnovsky et al. teaches it is well known to use a mechanism for rotating the workpiece in a plasma doping apparatus in order to ensure uniform implantation. Thus, it would have been obvious to one of ordinary skill in the art at the time of the invention to provide the platen of Liebert et al. with a rotating mechanism that rotates at speeds in a range between 0-2000 rpm as taught by Foster et al. or Vesnovsky et al. in order to pump the plasma down to the substrate and achieve uniform processing or implantation. Additionally, it should be noted that since the plasma is non-uniform in the apparatus of Liebert et al. in view of Foster et al., rotating the workpiece ensures that all of the exposed workpiece surface is processed by the entire non-uniform plasma environment, and thus achieve uniform doping or "averaging azimuthal uniformity

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variations" on the workpiece. Furthermore, with respect to the claimed limitations of "averaging azimuthal uniformity variations", it should be noted that claims directed to an apparatus must be distinguished from the prior art in terms of structure rather than function.

With respect to claim 3, the pulse source of Liebert et al. has a pulse rate of 100 Hz to 2 kHz which is capable of operating at a faster rate than the rotational speed of Foster et al. at 0-2000 rpm.

## Claim Rejections - 35 USC § 102

3. The following is a quotation of the appropriate paragraphs of 35 U.S.C. 102 that form the basis for the rejections under this section made in this Office action:

A person shall be entitled to a patent unless -

- (b) the invention was patented or described in a printed publication in this or a foreign country or in public use or on sale in this country, more than one year prior to the date of application for patent in the United States.
- 4. Claim 5 is rejected under 35 U.S.C. 102(b) as being anticipated by Nakayama et al. (Japanese Patent Publication 01-022027).

Referring to Drawing 1 and the abstract, discloses a plasma doping apparatus comprising: a plasma doping chamber 1 containing a platen 4a for supporting a workpiece 6; a plasma source 10 for generating a plasma in the plasma doping chamber and for accelerating ions from the plasma into the workpiece; and a drive mechanism for rotating the workpiece. Additionally, it should be noted that since the plasma is non-uniform in the apparatus of Nakayama et al., rotating the workpiece ensures that all of the exposed workpiece surface is processed by the entire non-uniform plasma environment, and thus achieve uniform doping or "averaging azimuthal uniformity variations" on the

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workpiece. Furthermore, with respect to the claimed limitations of "averaging azimuthal" uniformity variations", it should be noted that claims directed to an apparatus must be distinguished from the prior art in terms of structure rather than function.

5. Claim 10 is rejected under 35 U.S.C. 102(b) as being anticipated by Liebert et al. (U.S. 6,020,592).

Referring to Figure 1 and column 4, line 32-column 5, line 33, Liebert et al. discloses a plasma doping apparatus comprising: a plasma doping chamber 10; a platen 14 located in the plasma doping chamber for supporting a workpiece 20 (col. 4, lines 32-36); a process gas source 36 coupled to the plasma doping chamber, wherein a plasma containing ion of the process gas is produced in a plasma discharge region between an anode and the platen (col. 5, lines 4-8); an anode 24 spaced apart from the platen in the plasma doping chamber, the anode having a spacing from the platen that is varied and adjusted for accelerating ions from the plasma into the workpiece (col. 4, lines 44-46); a pulse source 30 for applying pulses between the platen and the anode for accelerating ions from the plasma into the workpiece (col. 4, lines 22-33).

6. Claims 11-14 are rejected under 35 U.S.C. 103(a) as being unpatentable over Liebert et al. (U.S. 6,020,592) in view of Hirata (Japanese Patent Publication 57-023227).

The teachings of Liebert et al. have been discussed above.

Liebert et al. fails to teach the anode comprises two or more anode elements and actuators for individually adjusting the spacing between the anode and the platen.

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Referring to Drawings 3, 4, 5, and 10 and the abstract, Hirata teaches a plasma processing apparatus wherein the anode comprises two or more anode elements 9, 10, 11 and actuators 15, 16, 17 for individually adjusting the spacing between the anode elements 9, 10, 11 and the platen 3 in order to obtain an uniform processing rate. Thus, it would have been obvious to one of ordinary skill in the art at the time of the invention for the anode of Liebert et al. to have two or more anode elements and actuators for individually adjusting the spacing between the anode and the platen as taught by Hirata in order to achieve an uniform processing rate.

Liebert et al. fails to teach that the two or more anode elements comprise annular rings.

Referring to Drawings 5 and 10, Hirata teaches a plasma processing apparatus wherein the two or more anode elements comprises an alternate shape of annular rings 74, 75,76. Thus, it would have been obvious to one of ordinary skill in the art at the time of the invention for the anode elements to be annular rings as taught by Hirata since this a known alternative configuration for plasma processing anodes. Additionally, the shape (annular rings) of the claimed anode elements is considered a matter of choice which a person of ordinary skill in the art would have found obvious absent persuasive evidence that the particular shape of the claimed anode elements are significant.

7. Claims 18-20, 22-25 and 27 are rejected under 35 U.S.C. 103(a) as being unpatentable over Liebert et al. (U.S. 6,020,592) in view of Setoyama et al. (U.S. 6,196,155).

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Referring to Figure 1 and column 4, line 32-column 5, line 33, Liebert et al. discloses a

plasma doping apparatus comprising: a plasma doping chamber 10; a platen 14 located in the plasma doping chamber for supporting a workpiece 20 (col. 4, lines 32-36); an anode 24 spaced apart from the platen in the plasma doping chamber (col.4, lines 44-46); a process gas source 36 coupled to the plasma doping chamber, wherein a plasma containing ion of the process gas is produced in a plasma discharge region between the anode and the platen (col.5, lines 4-8); a pulse source 30 for applying pulses between the platen and the anode for accelerating ions from the plasma into the workpiece (col.4, lines 50-57, col.5, lines 22-33).

Liebert et al. fails to specifically teach that the chamber having a cylindrical geometry.

Referring to column 2, lines 25-26, Setoyama et al. teaches a plasma processing apparatus having a chamber with a cylindrical geometry. It is conventionally known in the art for a chamber to have a cylindrical geometry. Thus, it would have been obvious to one of ordinary skill in the art at the time of the invention to for the chamber of Liebert et al. to have a cylindrical geometry since this feature is conventionally known in the art.

Liebert et al. fails to teach a plurality of magnetic elements disposed around the plasma discharge region

Referring to Figure 1 and column 4, line 52-column 6, line 49, Setoyama et al. teaches a plasma processing apparatus having a plurality of magnetic elements 20a and 20b disposed around the plasma discharge region for efficiently confining the plasma for processing and easily maintaining the plasma density (col.6, lines 1-4). Additionally, the

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magnetic elements are disposed on or near the anode 9. Furthermore, the magnetic elements are arranged in one or more annular rings (col. 5, lines 1-2). Moreover, the magnetic elements 20a and 20b have alternating polarities facing the plasma discharge region (col. 5, lines 1-6). Also, the magnetic elements 20b are arranged in a cylindrical array around the plasma discharge region (col. 5, lines 4-6). In addition, the magnetic elements produce cusp magnetic fields 30 in a region adjacent to the plasma discharge region (see Fig. 1). Thus, it would have been obvious to one of ordinary skill in the art at the time of the invention to provide the apparatus of Liebert et al. with the magnetic elements disposed around the plasma discharge region as taught by Setoyama et al. in order to efficiently confine the plasma for processing and to easily maintain the plasma density

8. Claim 21 is rejected under 35 U.S.C. 103(a) as being unpatentable over Liebert et al. (U.S. 6,020,592) in view of Setoyama et al. (U.S. 6,196,155) as applied to claims 18-20, 22-25 and 27 above, and further in view of Shan et al. (U.S. 6,022,446).

The teachings of Liebert et al. in view of Setoyama et al. have been discussed above.

Liebert et al. in view of Setoyama et al. fail to teach magnetic elements which are radially aligned to form a spoke configuration.

Referring to Figure 4a and column 8, lines 23-49, Shan et al. teaches a plasma processing apparatus wherein the magnetic elements 90 are radially aligned to form a spoke configuration. With this spoke configuration, a radially symmetrical magnetic field is generated to enhance processing rates. Thus, it would have been obvious to one

of ordinary skill in the art at the time of the invention to arrange the magnetic elements of Liebert et al. in view of Setoyama et al. in a spoke configuration as taught by Shan et al. since a radially symmetrical magnetic field is generated to enhance processing rates.

9. Claim 26 is rejected under 35 U.S.C. 103(a) as being unpatentable over Liebert et al. (U.S. 6,020,592) in view of Setoyama et al. (U.S. 6,196,155) as applied to claims 18-20, 22-25 and 27 above, and further in view of Goeckner et al. (U.S. 6,182,604).

The teachings of Liebert et al. in view of Setoyama et al. have been discussed above.

Liebert et al. in view of Setoyama et al. fail to teach a hollow electrode surrounding the plasma discharge region.

Referring to Figure 2a-b and column 5, line 26-column 6, line 6, Goeckner et al. teaches a plasma doping apparatus which uses a hollow electrode 300 surrounding the plasma discharge region in order to produce a more uniform plasma at a lower gas pressure. Thus, it would have been obvious to one of ordinary skill in the art at the time of the invention to provide the apparatus of Liebert et al. in view of Setoyama et al. with a hollow electrode surrounding the plasma discharge region as taught by Goeckner et al. in order to produce a more uniform plasma at a lower gas pressure. Additionally, the apparatus of Liebert et al. in view of Setoyama et al. and Goeckner et al. is capable of positioning magnetic elements near the hollow electrode.

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10. Claim 26 is rejected under 35 U.S.C. 103(a) as being unpatentable over Liebert et al. (U.S. 6,020,592) in view of Setoyama et al. (U.S. 6,196,155) as applied to claims 18-20, 22-25 and 27 above, and further in view of Little et al. (U.S. 4,443,488).

The teachings of Liebert et al. in view of Setoyama et al. have been discussed above.

Liebert et al. in view of Setoyama et al. fail to teach a hollow electrode surrounding the plasma discharge region.

Referring to Figure 1 and column 2, line 55-column 4, line 46, Little et al. teaches a plasma processing apparatus which uses a hollow electrode 22 surrounding the plasma discharge region 12, wherein magnetic elements 30 are disposed near the hollow electrode in order to produce a large volume, low pressure, high temperature plasma yielding very high energy, charged ions. Thus, it would have been obvious to one of ordinary skill in the art at the time of the invention to provide the apparatus of Liebert et al. in view of Setoyama et al. with a hollow electrode surrounding the plasma discharge region as taught by Goeckner et al. in order to produce a large volume, low pressure, high temperature plasma yielding very high energy, charged ions.

## Response to Arguments

Applicant's arguments filed March 31, 2005 have been fully considered but they are not persuasive.

Applicant has argued that since Foster et al. is directed to CVD processes in which a film is deposited on a substrate, a process for rotating the workpiece which averages azimuthal uniformity variations is not suggested because the invention is a

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plasma doping processing. Applicant further argued that CVD and doping are unique and different processes. However, both CVD processing and doping are analogous art since they both solve problems in the field of plasma processing. Additionally, the only difference between a doping apparatus and a CVD apparatus is the type of gas used during processing and thus the apparatus of Liebert et al. could be used as a CVD apparatus or the apparatus of Foster et al. could be used as a doping apparatus simply by changing the process gases (i.e. depositing gases, doping gases). Furthermore, in plasma processing systems it is well known that the plasma distribution is non-uniform. One way of compensating for the non-uniformity is to rotate the workpiece which allows all of the workpiece surface to be processed by the whole non-uniform plasma environment and therefore achieve an uniform process (i.e. depositing or doping) or "averages azimuthal uniformity variations" on the workpiece. Moreover, a claim containing a "recitation with respect to the manner in which a claimed apparatus is intended to be employed (i.e. a process for rotating the workpiece which averages azimuthal uniformity variations) does not differentiate the claimed apparatus from a prior art apparatus" if the prior art apparatus teaches all the structural limitations of the claim. Lastly, Vesnovsky et al. teaches rotating a workpiece during a plasma doping process. Thus, the rejection using Liebert et al. in view of Foster et al. and Vesnovsky et al. satisfy the claimed requirement.

Applicant has argued that Hirata fails to teach varying and adjusting the spacing between an anode and platen for accelerating ions from the plasma into the workpiece.

However, as discussed in new rejection using Liebert et al., Liebert et al. clearly discloses varying and adjusting the spacing between an anode and platen. Furthermore, a claim

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containing a "recitation with respect to the manner in which a claimed apparatus is intended to be employed (i.e. varying and adjusting the spacing between an anode and platen for accelerating ions from the plasma into the workpiece) does not differentiate the claimed apparatus from a prior art apparatus" if the prior art apparatus teaches all the structural limitations of the claim. Thus, since the Liebert et al. teaches the structure for varying and adjusting the spacing between an anode and platen, the rejection using Liebert et al. satisfies the claimed requirement.

Applicant has argued that Setoyama et al. or Shan et al fails to teach controlling the radial density distribution of the plasma so that the dose uniformity of the ions implanted into the workpiece is improved. It should be noted that the present invention is apparatus claims and the requirement for apparatus claims is for the prior art to teach all the structural limitation of the claim. As stated above, a claim containing a "recitation with respect to the manner in which a claimed apparatus is intended to be employed (i.e. controlling the radial density distribution of the plasma so that the dose uniformity of the ions implanted into the workpiece is improved) does not differentiate the claimed apparatus from a prior art apparatus" if the prior art apparatus teaches all the structural limitations of the claim. Thus, in claim 18, Setoyama et al. teaches the structure of a plurality of magnetic elements disposed around the plasma discharge region and Shan et al. teaches the structure of a spoke configuration, therefore the rejection of Liebert et al. in view of Setoyama et al. and Shan et al. satisfies the claimed requirement.

Applicant has argued that Nakayama et al. fails to teach rotating the workpiece which averages azimuthal uniformity variations. It should be noted that the present invention is apparatus claims and the requirement for apparatus claims is for the prior art

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to teach all the structural limitation of the claim. As stated above, a claim containing a "recitation with respect to the manner in which a claimed apparatus is intended to be employed (i.e. rotating the workpiece which averages azimuthal uniformity variations) does not differentiate the claimed apparatus from a prior art apparatus" if the prior art apparatus teaches all the structural limitations of the claim. Thus, in claim 5, Nakayama et al. teaches the structure rotating the workpiece, therefore the rejection of Nakayama et al. satisfies the claimed requirement.

Any inquiry concerning this communication or earlier communications from the examiner should be directed to Michelle Crowell whose telephone number is (571) 272-1432. The examiner can normally be reached on M-F (9:30 -6:00).

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Parviz Hassanzadeh can be reached on (571) 272-1435. The fax phone number for the organization where this application or proceeding is assigned is 703-872-9306.

Information regarding the status of an application may be obtained from the Patent Application Information Retrieval (PAIR) system. Status information for published applications may be obtained from either Private PAIR or Public PAIR. Status information for unpublished applications is available through Private PAIR only. For more information about the PAIR system, see http://pair-direct.uspto.gov. Should you have questions on access to the Private PAIR system, contact the Electronic Business Center (EBC) at 866-217-9197 (toll-free).

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